

Linker flags:

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--lto --remove
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Symbol	Description	Min.	Typ.	Max.	Units
CM _{RRAMCACHE128}	CPU running CoreMark at 128 MHz from RRAM, cache enabled	503			CoreMark
CM _{ram128/MHz}	CoreMark per MHz, running from RRAM, cache enabled, HFXO128M	3.93			CoreMark/ MHz
CM _{RAM128}	CPU running CoreMark at 128 MHz from RAM	464			CoreMark

11.4.2 CPU wakeup times

Symbol	Description	Min.	Typ.	Max.	Units
t _{R2ON}	Time from pin reset to CPU executes the first instruction	60			μs
t _{OFF2ON}	Time from wake-up from System OFF mode to CPU executes the first instruction	60			μs
t _{IDLE2CPU}	Wakeup time from CPU sleep (WFI,WFE) to CPU executes the next instruction	13			μs
t _{IDLE2CPU,CONSTLAT}	Wakeup time from CPU sleep (WFI,WFE) to CPU executes the next instruction in constant latency sub-mode	9			μs

11.5 GPIO Electrical specification

11.5.1 GPIO Electrical Specification

Symbol	Description	Min.	Typ.	Max.	Units
V _{IH}	Input high voltage	0.7 x VDD	VDD	V	
V _{IL}	Input low voltage	VSS	0.3 x VDD	V	
V _{OH,SD}	Output high voltage, standard drive, 0.5 mA, VDD ≥ 1.7	VDD - 0.4	VDD	V	
V _{OH,HDH}	Output high voltage, high drive, 5 mA, VDD ≥ 2.7 V	VDD - 0.4	VDD	V	
V _{OH,HDL}	Output high voltage, high drive, 3 mA, VDD ≥ 1.7 V	VDD - 0.4	VDD	V	
V _{OL,SD}	Output low voltage, standard drive, 0.5 mA, VDD ≥ 1.7	VSS	VSS + 0.4	V	
I _{OL,SD}	Current at VSS+0.4 V, output set low, standard drive, VDD ≥ 1.7	1	3	4	mA
I _{OL,HDL}	Current at VSS+0.4 V, output set low, high drive, VDD ≥ 1.7 V	3			mA
I _{OL,ED}	Current at VSS+0.4 V, output set low, extra drive, VDD ≥ 1.7 V	16			mA
I _{OH,SD}	Current at VDD-0.4 V, output set high, standard drive, VDD ≥ 1.7	1	3	4	mA
I _{OH,HDL}	Current at VDD-0.4 V, output set high, high drive, VDD ≥ 1.7 V	4			mA
I _{OH,ED}	Current at VDD-0.4 V, output set high, extra drive, VDD ≥ 1.7 V	14			mA
I _{GPIO,TOTAL}	Recommended maximum sustained current drawn by all GPIOs			15	mA
t _{HRF,12pF}	Rise/Fall time, high drive mode, 20-80%, 12 pF load ¹		4		ns
t _{ERF,12pF}	Rise/Fall time, extra drive mode, 20-80%, 12 pF load ¹		0.9		ns
R _{PU}	Pull-up resistance	12	14	16	kΩ
R _{PD}	Pull-down resistance	12	14	18	kΩ
t _{OE,ED}	Output enable delay in extra drive mode			855	ns
C _{PAD}	Pad capacitance		1		pF
C _{PAD_NFC}	Pad capacitance on NFC pads		5		pF